

# «COOLING TECHNOLOGIES»

IEA Technology Collaboration Programme on  
Heat Pumping Technologies (HPT TCP)

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[www.heatpumpingtechnologies.org](http://www.heatpumpingtechnologies.org)



# A/C TECHNOLOGIES AND MARKETS

## In the Past

- Substantial declines in product and lifecycle cooling costs in many A/C markets
- Higher sales volumes
- Higher energy efficiency
- Transition away from ozone-depleting substances (ODS)



## Expectations for the future

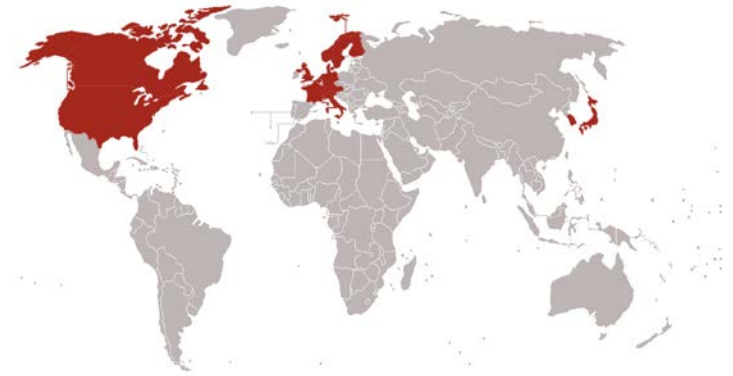
- Rapid growth of A/C markets in developing nations with hot, humid climates
- Increased frequency of extreme heat waves due to global warming
- Continued efficiency improvements
- Transition to low-Global Warming Potential (GWP) refrigerants
- Advancement of non-vapor-compression A/C technologies
- Cooperation with other TCP's



# WHAT IS THE HPT TCP?

- A Technology Collaboration Programme (TCP) within **the IEA** since **1978**
- An international framework of **cooperation** and **networking** for different HP actors
- A forum to exchange **knowledge** and **experience**
- A contributor to **technology improvements** by RDD&D projects

## 16 Participating Countries

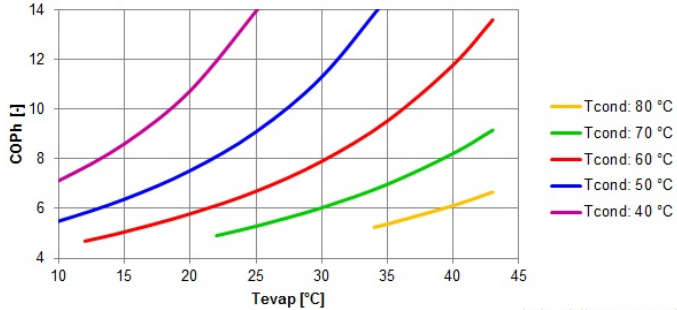
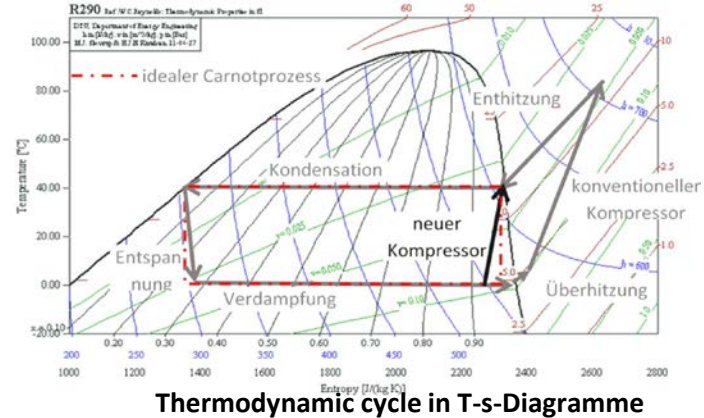
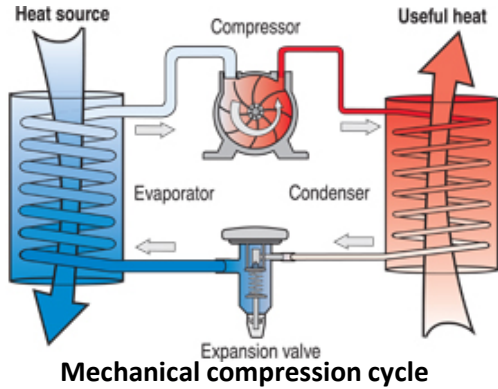


Austria  
Belgium  
Canada  
Denmark  
Finland  
France  
Germany  
Italy

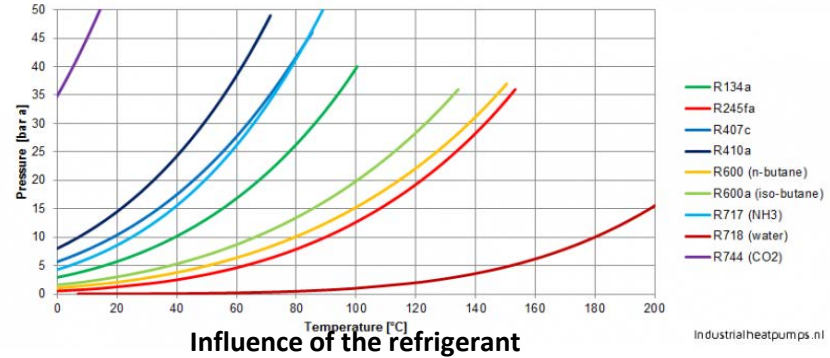
Japan  
Netherlands  
Norway  
South Korea  
Sweden  
Switzerland  
United Kingdom  
United States



# WHAT IS - HEAT PUMPING TECHNOLOGIES



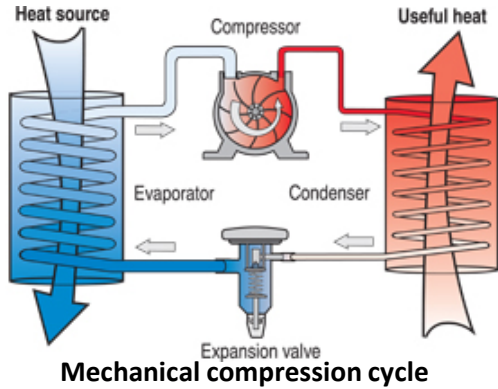
Industrialheatpumps.nl



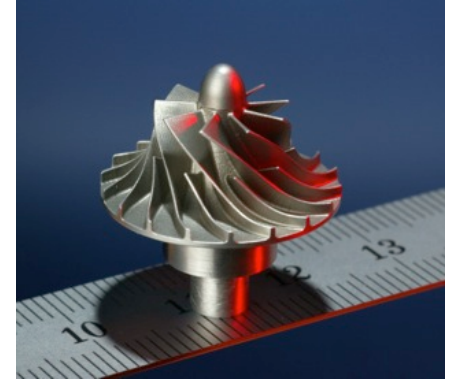
Industrialheatpumps.nl



# WHAT IS - HEAT PUMPING TECHNOLOGIES

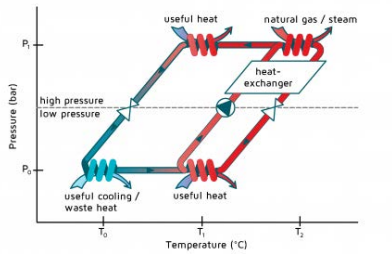


Large heat pumps ....

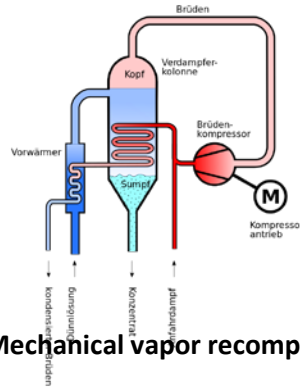


..... small heat pumps

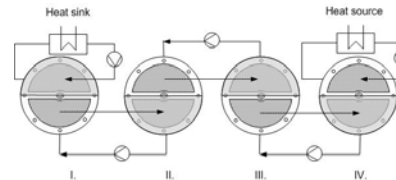
## Other heat pump cycles



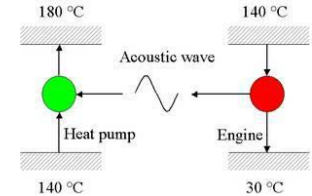
Absorption heat pump



Mechanical vapor recompression



Electro-magnetic heat pump

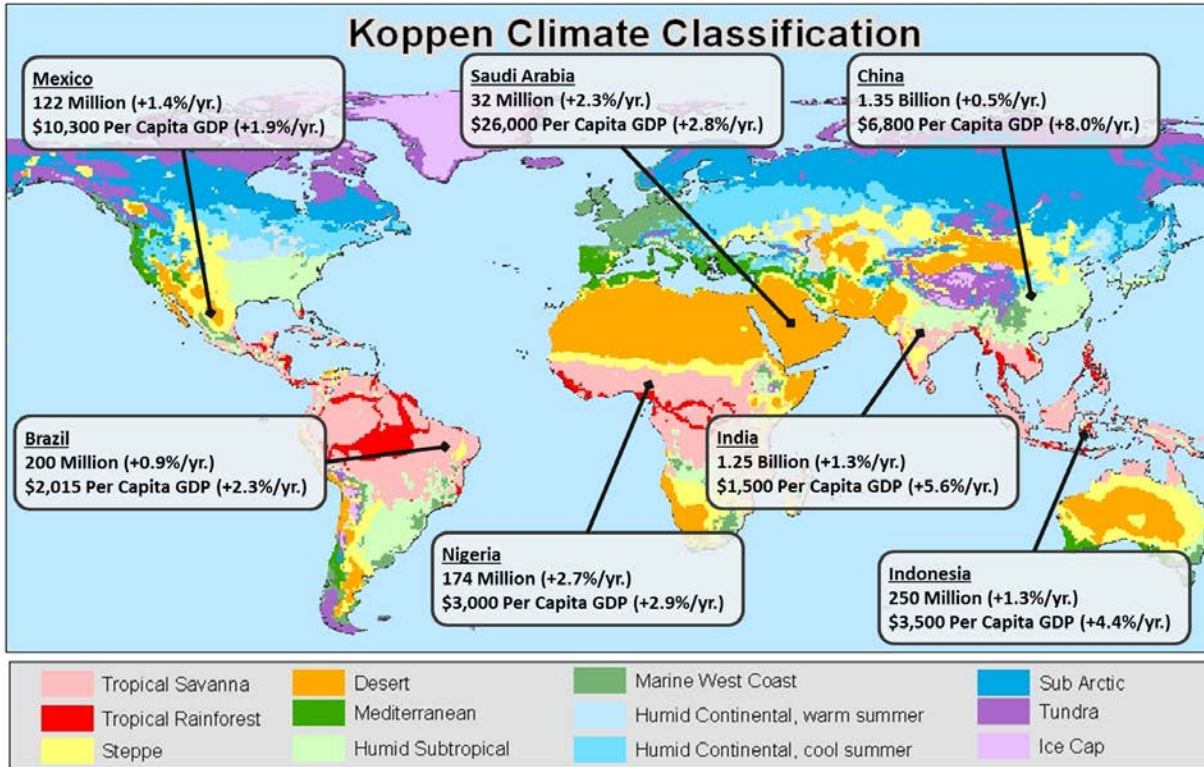


Thermo-acoustic heat pump



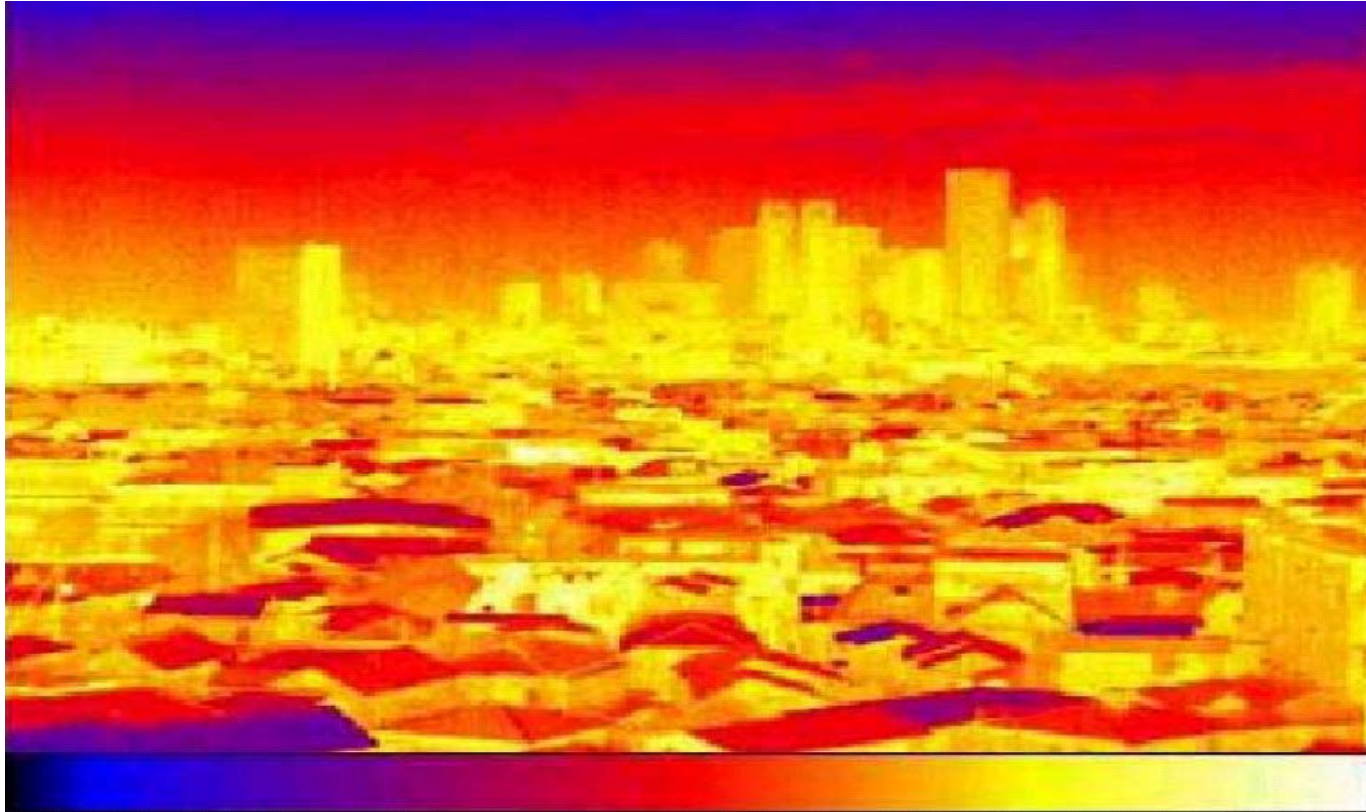


# DEVELOPMENT OF SPACE COOLING DEMAND (1/3)



Many countries with strong population and GDP growth are in hot and humid climates, further driving increased A/C use.

## DEVELOPMENT OF SPACE COOLING DEMAND (2/3)

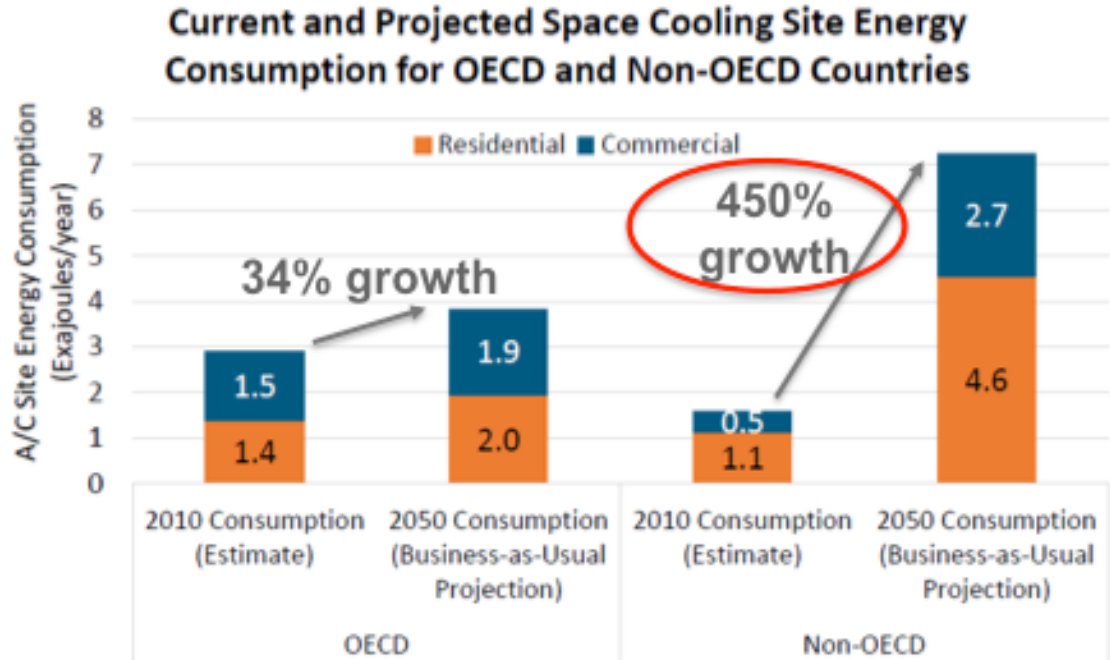


Heat  
island  
effect



# DEVELOPMENT OF SPACE COOLING DEMAND (3/3)

- Aggressive growth of A/C energy consumption by 2050 will be driven primarily by non-OECD countries.
- Rising standards of living and population growth drives increased A/C adoption.
- Current A/C penetration in developing nations is limited, e.g., 3% in 2010 in India
- **India alone has potential space cooling demand that is 14 times larger than that of the U.S**





# CHALLENGES AND OPPORTUNITIES OF COOLING TECH'S

- **Efficiency of the thermo cycle**
  - **Dehumidification**
  - **Global Warming Potential (GWP) of the refrigerant**
  - Energy transfer from the room
  - Energy transfer to the environment
  - Required temperature lift
  - Decentralised or central solution
  - Source of electricity (and its GWP)
- Electricity grid (capacity, total energy and peak loads)
  - Other energy sources/sinks
  - Need & Opportunities of storage system
  - Existing building stock or new
  - Size of the building
  - Purpose of the building
  - Standard of building technologies
  - “Culture” of thermal comfort



# EMERGING R&D SOLUTIONS FOR COOLING TECH'S

- **Advanced Vapor-Compression Systems**

- A/C technologies that significantly lower refrigerant GWP and energy consumption while maintaining cost-competitiveness; for example:
  - Low-GWP refrigerants (e.g., natural refrigerants and synthetic olefins)
  - Climate-specific designs

- **Emerging Non-Vapor-Compression (NVC) Systems**

- A/C technologies that do not rely on refrigerant-based vapor-compression and can provide energy savings (with high-volume cost similar to today's); for example:
  - Solid-state & caloric (thermoelectric, magnetocaloric)
  - Electro-mechanical (evaporative, thermoelastic)
  - Thermally driven (absorption)

- **Integration of A/C and Other Building Systems**

- A/C technologies that share excess heat and other resources with other systems to provide significant savings for the building; for example:
  - Capturing waste energy from A/C **for water heating** and dehumidification



# Outcome from Annex 40 Heat Pumps and NZEBs

## Temperature and Humidity Individual Control HVAC System with the New Desiccant Device – DESICA-

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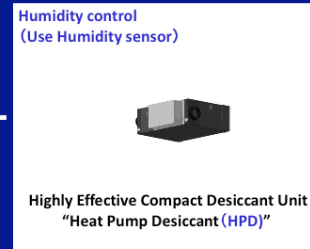
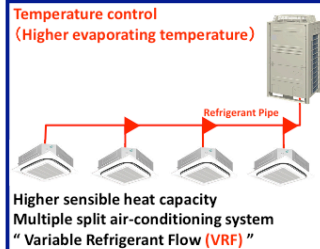


November. 11, 2014  
Annex 40 Workshop

1

## Introduction of the New HVAC System

THIC can achieve higher performance in each of the sensible or latent heat treatment



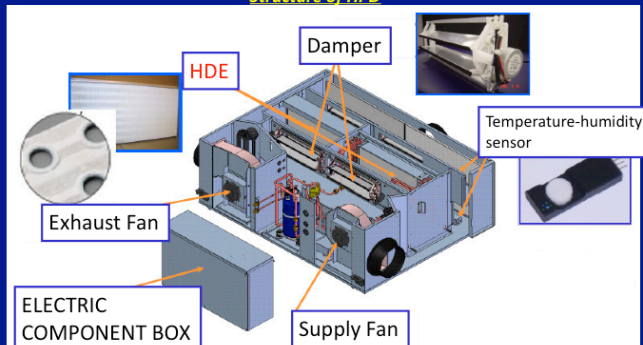
- For temperature, performance improvement was easily achieved by raising evaporating temperature.
- For humidity, we focused on desiccant technology to achieve high performance.

9

## High Performance Heat Pump Desiccant system

The HP desiccant is realized with 2.5 times higher performance and 1/3 of compactness.

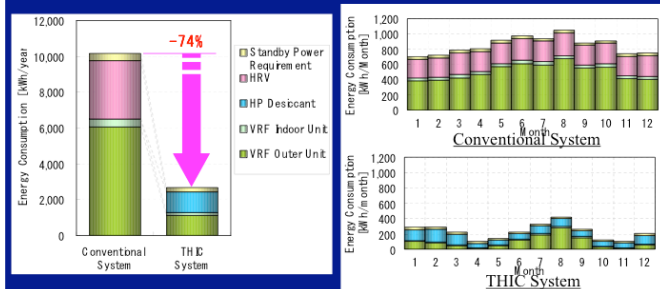
Structure of HPD



19

## Evaluation of the Whole Year Operation

In case that the THIC system is installed in the high quality buildings, total amount of the energy consumption through a year will be reduced by more than 70%.



www

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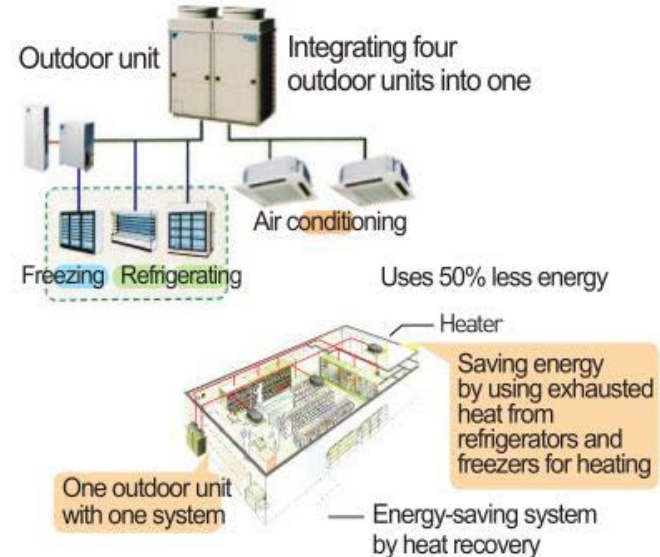
# RECENT DEVELOPMENTS IN COOLING TECH'S

- **Membrane air conditioner**

- Dehumidification by nano-composite membrane instead of cooling
- Development of membrane heat and mass exchanger
- Development of prototype air conditioner and feasibility test
- One of the candidate technologies in DOE report of non-vapor compression HVAC technologies.

- **Integrated system of refrigeration, air conditioning and freezing**

- Combined with a heat pump system
- Target for commercial sector like supermarket



# DIRECT VS. INDIRECT GHG EMISSIONS IMPACTS

- 2010 global A/C GHG emissions:
  - Direct (HFC, HCFC refrigerant emissions during operation, end-of-life) → 26% or 175 MMtCO<sub>2</sub>-eq
  - Indirect (CO<sub>2</sub> emissions from electricity generation) → 74% or 516 MMtCO<sub>2</sub>-eq
- Electricity consumption is the largest driver of global A/C GHG emissions, but simultaneous pursuit of reductions in BOTH direct and indirect emissions is required to achieve international goals.
- Direct emissions in developing countries are typically higher than in developed countries.
  - Few developing countries have in-service recovery or end-of-life recycling regulations
  - Leads to deliberate venting of refrigerants





# LOW-GWP PRODUCT AVAILABILITY

Products using low-GWP, 4<sup>th</sup> generation refrigerants are already available in some applications.

- Offer comparable or improved efficiency relative to today's typical equipment
- Currently available in four key product categories, including ductless split systems, by far the largest market segment globally (>60% of the market)
- Flammability and cost are key limiting factors

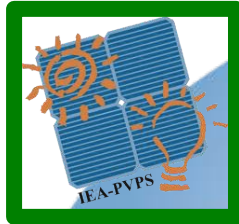
Equipment	Status	Approved for use in U.S.	U.S. SNAP Application Submitted	Example		2012 Global Annual Sales (US\$B)		
				Best GWP	Detail			
Residential	Room and portable	●	✓	✓	<10	R-290; R-32	\$3.4	★
	Ducted split & single-package	◐		✓	<700	Multiple candidates	\$3.3	
	Ductless split system	●	✓	✓	<10	R-32; R-290	\$48.5	★
Commercial	Packaged terminal	◐	✓	✓	<700	R-32	\$0.2	
	Packaged rooftop unit	◐		✓	<700	Multiple candidates	\$4.6	
	Ductless (VRF/VRV)	◐			<700	R-32	\$10.7	
	Scroll / recip. chiller	◐		✓	<700	DR-55 (R-452B)		★
	Screw chiller	●	✓	✓	<10	R-513A; R-1234ze(E)	\$8.3	
Centrifugal chiller	●	✓	✓	<10	R-1233zd(E), R-1234ze(E)	(all chillers)	★	

Source for market size: Approximate 2012 global sales data (includes equipment using all refrigerants) from BSRIA; U.S approval status from EPA website

●	Commercially available in some global markets;	◐	Product under development;	◑	Tested in Lab
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# HPT TCP AND OTHER TCP'S

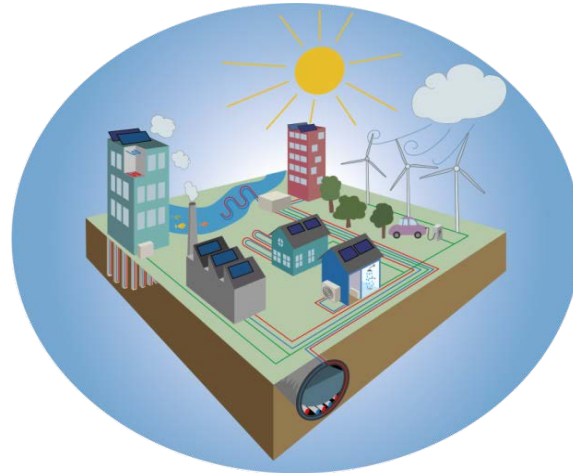


4<sup>E</sup>



# COOLING TECHNOLOGIES FOR THE NEXT DECADE

- **Flexible, sustainable and clean system solutions** (e.g. in urban areas) using combinations of heat pumping technologies with **energy storage, smart grid, solar and wind energy, thermal networks, energy prosumers**



**Thanks  
for your  
attention**

